

FEATURES

AIWAN

ICONDUCTOR

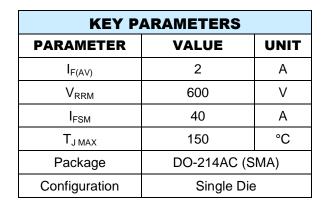
- Fast forward recovery time for high frequency operation
- Negligible switching losses
- Reduces switching and conduction losses
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Designed for high frequency switching mode inverters and converters for consumer, computers, lighting, automotive and telecommunications
- The low IRRM is an immediately advantage to reduce the switching losses in associated of switching devices. Also suitable as priority protection and other rectifications purposes

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Part No. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.07 g (approximately)







DO-214AC (SMA)

ABSOLUTE MAXIMUM RATINGS (T _A	= 25°C unless	s otherwise noted)	
PARAMETER	SYMBOL	UG2JA	UNIT
Marking code on the device		UG2JA	
Repetitive peak reverse voltage	V _{RRM}	600	V
Reverse voltage, total rms value	V _{R(RMS)}	420	V
Maximum DC blocking voltage	V _{DC}	600	V
Forward current	I _{F(AV)}	2	А
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	40	А
Junction temperature	TJ	- 55 to +150	°C
Storage temperature	T _{STG}	- 55 to +150	°C



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction-to-lead thermal resistance	R _{θJL}	25	°C/W	
Junction-to-ambient thermal resistance	R _{eja}	70	°C/W	

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	МАХ	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 2A, T_J = 25^{\circ}C$	V _F	-	1.3	V
\mathbf{D} as the difference of (2)	$T_J = 25^{\circ}C$		-	2.0	μA
Reverse current @ rated V_R per diode $^{(2)}$	T _J = 125°C	I _R	-	50	μA
Reverse recovery time	I _F =0.5A,I _R =1.0A I _{RR} =0.25A	t _{rr}	40	55	ns
Forward recovery time	IF=2A, dI _F /dt=100A/µs, V _{FR} =1.1 x V _{Fmax}	t _{fr}	-	100	ns
Forward recovery voltage	IF=2A, dI _F /dt=100A/µs, V _{FR} =1.1 x V _F max	V _{FP}	-	9	V
Junction capacitance	1 MHz, V _R =4.0V	CJ	20	-	pF

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms

ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX(*)	PACKAGE	PACKING
UG2JA H	F2		Folded SMA	7,500 / 13" Paper reel	
		F3	G	Folded SMA	1,800 / 7" Plastic reel
	н	F4		Folded SMA	7,500 / 13"Plastic reel
		R3		SMA	1,800 / 7" Plastic reel
		M2		SMA	7,500 / 13"Plastic reel

*: Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
UG2JAHF2G	UG2JA	Н	F2	G	AEC-Q101 qualified Green compound



Fig.2 Typical Junction Capacitance

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

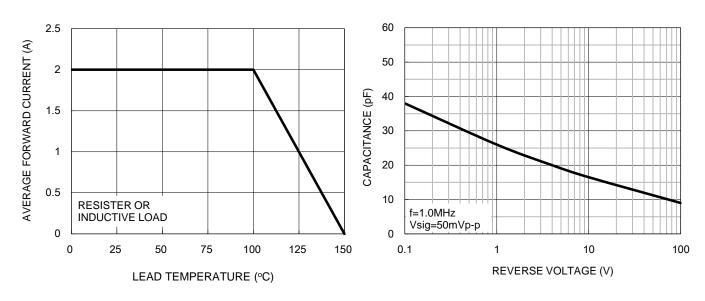
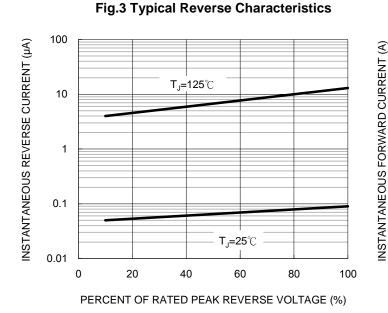


Fig.1 Forward Current Derating Curve

Fig.4 Typical Forward Characteristics



10 T_**=125**℃ 1 T_**=25**℃ Pulse width=300µs 1% duty cycle 0.1 0.4 0.6 0.8 1 1.2 1.4 1.6 1.8 FORWARD VOLTAGE (V)



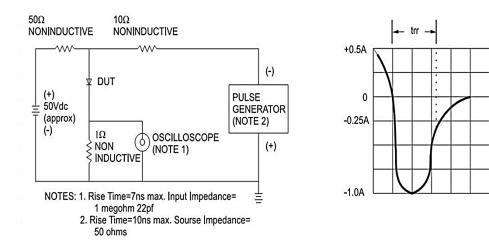
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current



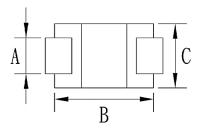
Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram

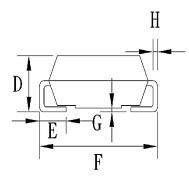




PACKAGE OUTLINE DIMENSIONS

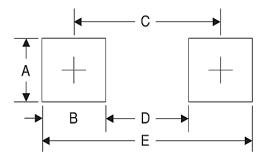
DO-214AC (SMA)





DIM.	Unit (r		mm) Unit (inch	
Dilvi.	Min	Max	Min	Max
А	1.27	1.58	0.050	0.062
В	4.06	4.60	0.160	0.181
С	2.29	2.83	0.090	0.111
D	1.99	2.50	0.078	0.098
Е	0.90	1.41	0.035	0.056
F	4.95	5.33	0.195	0.210
G	0.10	0.20	0.004	0.008
Н	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM

P/N S≣GYWF

P/N G	= Marking Code = Green Compound
YW	= Date Code
F	= Factory Code



Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.